

PA610ATF-VB Datasheet N-Channel 100-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------------------|------------------------|-------|--|--|
| V _{DS} (V) | 100 | | | |
| $R_{DS(on)}\left(\Omega\right)$ | V _{GS} = 10 V | 0.086 | | |
| Q _g (Max.) (nC) | 72 | | | |
| Q _{gs} (nC) | 11 | | | |
| Q _{gd} (nC) | 32 | | | |
| Configuration | Single | | | |

FEATURES

- · Isolated Package
- High Voltage Isolation = 2.5 kV_{RMS} (t = 60 s;



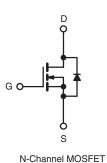
- 175 °C Operating Temperature
- · Dynamic dV/dt Rating
- · Low Thermal Resistance
- Lead (Pb)-free Available





TO-220 FULLPAK





| ABSOLUTE MAXIMUM RATINGS T | _C = 25 °C, u | nless otherw | ise noted | | | |
|--|-------------------------|-----------------------------------|-----------------|------------------|----------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V_{DS} | 100 | V | |
| Gate-Source Voltage | | | V_{GS} | ± 20 | 1 v | |
| Continuous Drain Current | V _{GS} at 10 V | T _C = 25 °C | I _D | 18 | | |
| Continuous Dialii Cuitetti | VGS at 10 V | T _C = 100 °C | | 12 | Α | |
| Pulsed Drain Current ^a | | | I _{DM} | 68 | | |
| Linear Derating Factor | | | | 0.32 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 720 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 17 | Α | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 4.8 | mJ | |
| Maximum Power Dissipation | T _C = 25 °C | | P_{D} | 48 | W | |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 5.5 | V/ns | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to + 175 | °C | | |
| Soldering Recommendations (Peak Temperature) | for 10 s | | | 300 ^d | | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf ⋅ in | |
| | | | | 1.1 | N · m | |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 3.7 mH, R_G = 25 Ω , I_{AS} = 17 A (see fig. 12). c. $I_{SD} \le 17$ A, $dI/dt \le 200$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.

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| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------------|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 65 | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 3.1 | C/VV | |

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|---|--|------|-------|------------------------|------------------|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = | 100 | - | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | - | 0.13 | - | V/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | $V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$ | | - | 3.0 | V |
| Gate-Source Leakage | I _{GSS} | , | V _{GS} = ± 20 V | - | - | ± 100 | nA |
| 7 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | | V _{DS} = | V _{DS} = 100 V, V _{GS} = 0 V | | - | 25 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 80 V | , V _{GS} = 0 V, T _J = 150 °C | - | - | 250 | μΑ |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 10 A ^b | - | 0.086 | - | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} = 50 V, I _D = 10 A ^b | | 9.1 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | V -0V | | - | 1700 | - | pF |
| Output Capacitance | C _{oss} | _ | $V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ | | 560 | - | |
| Reverse Transfer Capacitance | C _{rss} | f = 1.0 MHz, see fig. 5 f = 1.0 MHz | | - | 120 | - | |
| Drain to Sink Capacitance | С | | | - | 12 | - | |
| Total Gate Charge | Qg | | I _D = 17 A, V _{DS} = 80 V, see fig. 6 and 13 ^b | - | - | 72 | nC |
| Gate-Source Charge | Q_{gs} | V _{GS} = 10 V | | - | - | 11 | |
| Gate-Drain Charge | Q _{gd} | 1 | | - | - | 32 | |
| Turn-On Delay Time | t _{d(on)} | | | | 11 | - | ns |
| Rise Time | t _r | $V_{DD} = 50 \text{ V, } I_D = 17 \text{ A,}$ $R_G = 9.1 \Omega, R_D = 2.9 \Omega,$ see fig. 10^b | | - | 44 | - | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 53 | - | |
| Fall Time | t _f | | | - | 43 | - | |
| Internal Drain Inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.5 | - | |
| Internal Source Inductance | L _S | | | - | 7.5 | - | nH |
| Drain-Source Body Diode Characteristic | s | | | | | | • |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 17 | - A |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 68 | |
| Body Diode Voltage | V_{SD} | $T_J = 25 ^{\circ}\text{C}, I_S = 17 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$ | | - | - | 2.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 17 A, dl/dt = 100 A/μs ^b | | | 180 | 360 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 1.3 | 2.6 | μС |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L _S | | | | y L _S and I | L _D) |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

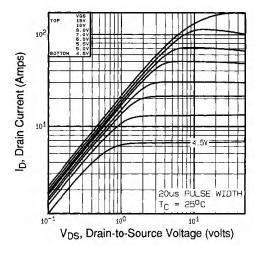


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

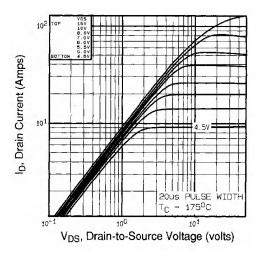


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

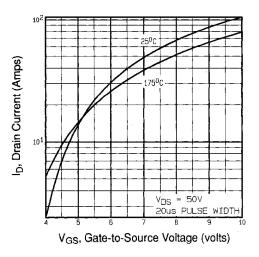


Fig. 3 - Typical Transfer Characteristics

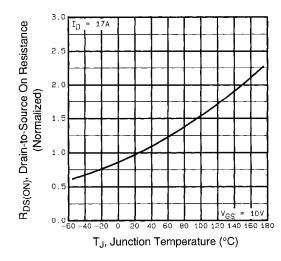


Fig. 4 - Normalized On-Resistance vs. Temperature



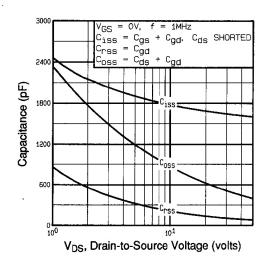


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

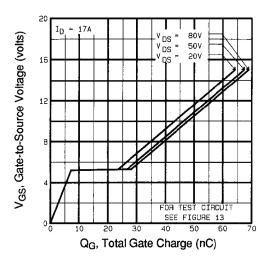


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

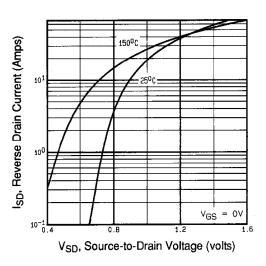


Fig. 7 - Typical Source-Drain Diode Forward Voltage

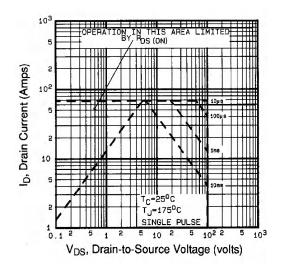


Fig. 8 - Maximum Safe Operating Area



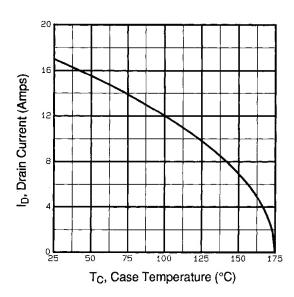


Fig. 9 - Maximum Drain Current vs. Case Temperature

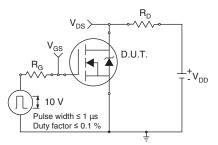


Fig. 10a - Switching Time Test Circuit

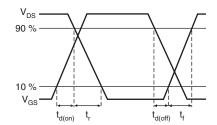


Fig. 10b - Switching Time Waveforms

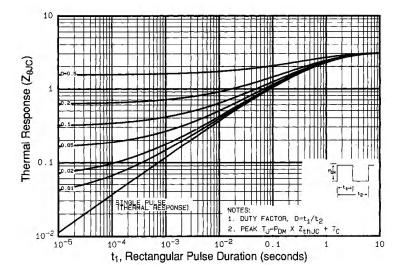


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

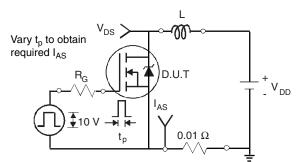


Fig. 12a - Unclamped Inductive Test Circuit

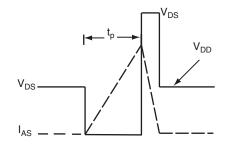


Fig. 12b - Unclamped Inductive Waveforms



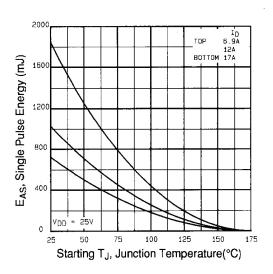


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

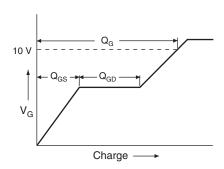


Fig. 13a - Basic Gate Charge Waveform

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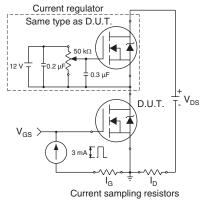


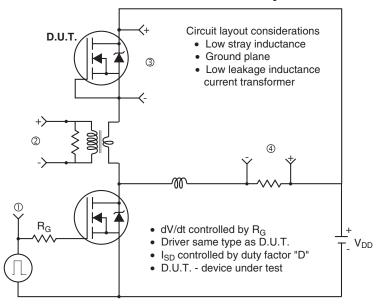
Fig. 13b - Gate Charge Test Circuit

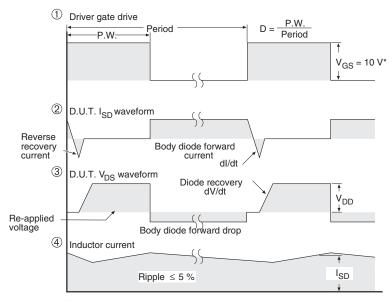
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Peak Diode Recovery dV/dt Test Circuit





* $V_{GS} = 5 V$ for logic level devices

Fig.14 - For N-Channel

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